



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

: Johannes Baur et al.

Art Unit

: Unknown

Serial No.

10/567,935

Examiner: Unknown

Filed

: February 9, 2006

Title

THIN-LAYER LIGHT-EMITTING DIODE CHIP AND METHOD FOR THE

PRODUCTION THEREOF

MAIL STOP AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Applicants request consideration of the references listed on the attached PTO-1449 form. Under 37 C.F.R. § 1.98 (a)(2)(ii), only copies of foreign patent documents and/or non-patent literature are enclosed. Copies of any listed U.S. patents or U.S. patent application publications can be provided upon request.

This statement is being filed within three months of the filing date of the application or before the receipt of a first Office Action on the merits. Please apply any charges or credits to Deposit Account No. 06-1050, referencing 12406-148US1.

Respectfully submitted,

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CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

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U.S. Department of Commerce Patent and Trademark Office Attorney's Docket No. 12406-148US1

Applicant

Application No. 10/567,935

lagormation Disclosure Statement
by Applicant
Use several sheets if necessary)

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Johannes Baur et al.

Filing Date February 9, 2006

Group Art Unit

TRADE	U.S. Patent Documents						
Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
	AA	5,310,623	05/10/1994	Gal			
-	AB	5,779,924	07/14/1998	Krames et al.			
	AC						
	AD						

Foreign Patent Documents or Published Foreign Patent Applications								
Examiner	Desig. ID	Document Number	Publication Date	Country or Patent Office		Subclass	Translation	
Initial					Class		Yes	No
	AE	101 35 190	02/06/2003	Germany	H01L	33/00	Abstract Only	
	AF	1 271 665	01/02/2003	EPO	H01L	33/00		
	AG	1 324 399	07/02/2003	ЕРО	H01L	33/00		
	AH	1 329 961	07/23/2003	ЕРО	H01L	33/00		
	AI	WO 01/41225	06/07/2001	WIPO	H01L	33/00		
	AJ							x-

Other Documents (include Author, Title, Date, and Place of Publication)					
Examiner	Desig.				
Initial	ID D	Document			
	AK	G.A. Neuman, "Anti-reflective coatings by APCVD using graded index layers", <u>Journal of Non-Crystalline Solids</u> , Vol. 218, pp. 92-99 (1997)			
	AL	H.J. Quenzer et al., "Anodic-Bonding on Glass Layers Prepared by Spin-on Glass Process: Preparation Process and Experimental Results", <u>Proceedings of Transducers 01/Eurosensors XV</u> , (June 10-14, 2001)			
	AM	I. Schnitzer et al., "30% external quantum efficiency from surface textured, thin-film light-emitting diodes", Applied Physics Letter, Vol. 63, No. 16, pp. 2174-2176 (October 18, 1993)			
	AN	S. Warnck "RELIEF – Mass production of low-cost products with microrelief surfaces by means of CD injection molding", <u>Information Series of VDI-VDE-Technologiezentrum Informationstechnik</u> <u>GmbH</u> , (German Federal Ministry for Education and Research) No. 36-2002 (German and English translation)			
	AO	R. Windisch et al., "Impact of texture-enhanced transmission on high-efficiency surface-textured light-emitting diodes", Applied Physics Letters, Vol. 79, No. 15, pp. 2315-2317 (October 8, 2001)			
	AP	Reducing Reflection by means of Submicron Structures in ORMOCER Layers, Fraunhofer Institute Silicate Research, http://www.isc.fraunhofer.de/gb/ormocere/o3_7.html			
	AQ				

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Examiner Signature	Date Considered				
EXAMINER: Initials citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with					
next communication to applicant.					